

C3225X8L1H475K200AC

TDK Item Description : C3225X8L1H475KT****



Application & Main Feature

Commercial Grade (High Temperature Application)

Series

C3225 [EIA 1210]



Dimensions

L	3.20mm +/-0.4mm
W	2.50mm +/-0.3mm
T	2.00mm +/-0.2mm
B	0.20mm Min.
G	

Temperature Characteristic

X8L (-55 to 150 degC +15,-40%)

Rated Voltage

1H(50Vdc)

Capacitance

4.7uF

Capacitance Tolerance

K (+/-10%)

Dissipation Factor

5% Max.

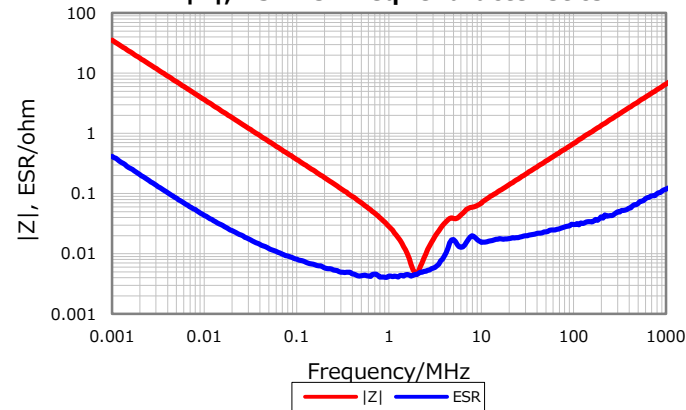
Insulation Resistance

106Mohm Min.

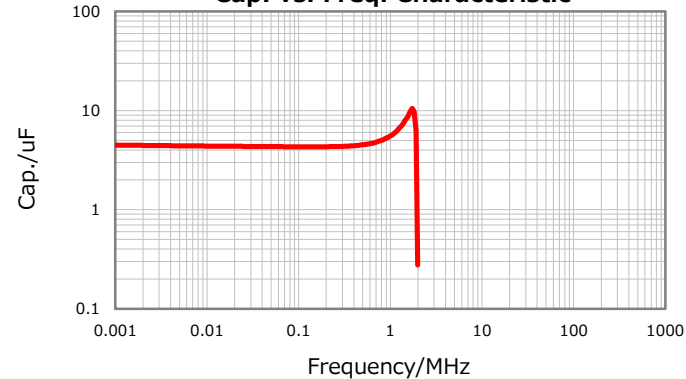
AEC-Q200

Not Applicable

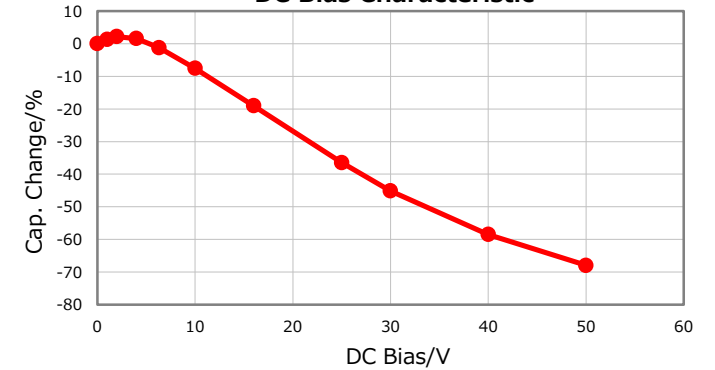
|Z|, ESR vs. Freq. Characteristics



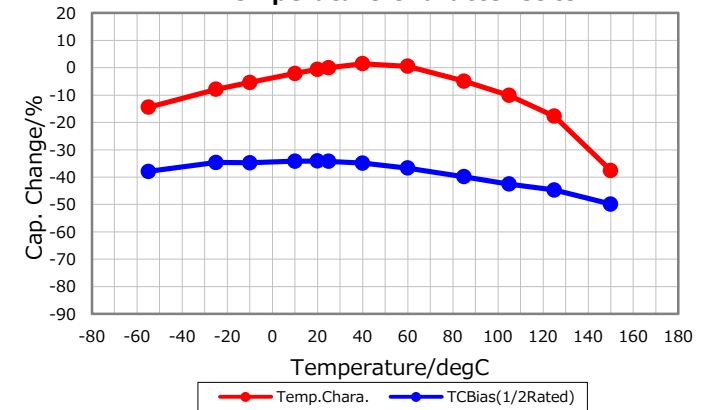
Cap. vs. Freq. Characteristic



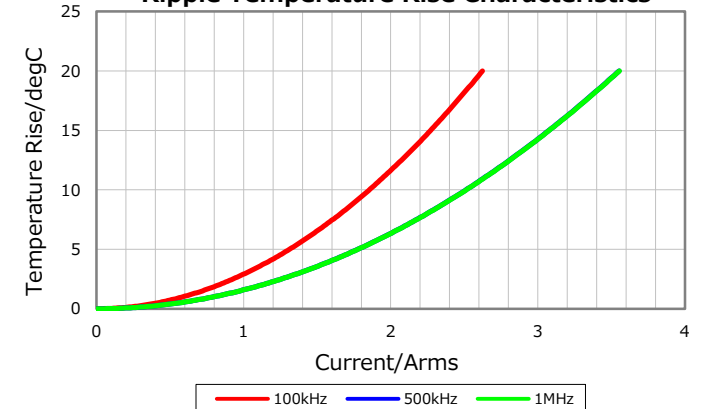
DC Bias Characteristic



Temperature Characteristics



Ripple Temperature Rise Characteristics



Characterization Sheet (Multilayer Ceramic Chip Capacitors)



All specifications are subject to change without notice.

June 19, 2017